

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t3492efe#trpbf

(Engineering Calculation)

TSSOP Exp. Pad

(printed on: 2020-07-11 17:50:31)

TOTAL MASS (g) : 0.095298

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003154	1000000	33096.0585938		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.030596	975000	321054.84375		
		Iron (Fe)	7439-89-6	0.000753	24000	7901.5		
		Phosphorus (P)	7723-14-0	0.000009	300	94.440246582		
		Zinc (Zn)	7440-66-6	0.000022	700	230.853927612		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.031380	1000000	329281.65625		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.002480	1000000	26027.2480469		
		External Plating Total:				0.002480	1000000	26027.2480469
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000806	1000000	8457.6484375		
Internal Plating Total:				0.000806	1000000	8457.6484375		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000958	750000	10052.6386719		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000319	250000	3347.38208008		
Die Attach Total:				0.001277	1000000	13400.0205078		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.007460	135000	78280.46875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.047524	860000	498686.46875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000276	5000	2896.16748047		
		Encapsulation Total:				0.055260	1000000	579863.0625
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000941	1000000	9874.25195312		
					TOTAL MASS (g) :	0.095298		